CENTRAL FAX CENTER

JUN 2 7 2006

## CHIP-PACKAGING WITH BONDING OPTIONS CONNECTED TO A PACKAGE SUBSTRATE

Appl. No. : 10/709,428

Confirmation No. 3427

Applicant

Cheng-Yen Huang

Filed

May 5, 2004

TC/A.U.

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Examiner :

TRINH, HOA B

Docket No.

FTCP0035USA0

Customer No.

27765

Commissioner for Patents

P.O. Box 1450

Alexandria VA 22313-1450

## AMENDMENT AND REQUEST FOR CONTINUED EXAMINATION

Sir:

In response to the Advisory action of May 17, 2006, please amend the above-identified application as follows:

Amendments to the Claims are reflected in the listing of claims which begins on page 2 of this paper.

Remarks/Arguments begin on page 4 of this paper. 10